

LINEAR TECHNOLOGY MATERIALS DECLARATION

1tc694cn8-3.3#pbf

(Engineering Calculation)

PDIP

(printed on: 2020-07-11 16:59:28)

TOTAL MASS (g) : 0.501089

COMPONENT MATERIAL	VENDOR/ INDUSTRY NAMES	CONSTITUENT NAME	CAS NUMBER	CONSTITUENT MASS (g)	CONSTITUENT (PPM) OF MATERIAL	CONSTITUENT (PPM) OF TOTAL PKG.		
Active Device	Linear Technology	Silicon (Si)	7440-21-3	0.003849	1000000	7681.26513672		
Die Coat	Dow Corning	Silicone	69430-27-9	0.000000	0	0		
Lead Frame	Cu	Copper (Cu)	7440-50-8	0.149760	975000	298868.84375		
		Iron (Fe)	7439-89-6	0.003686	24000	7355.97363281		
		Phosphorus (P)	7723-14-0	0.000046	300	91.8000030518		
		Zinc (Zn)	7440-66-6	0.000108	700	215.530426025		
		Nickel (Ni)	7440-02-0	0.000000	0	0		
		Silicon (Si)	7440-21-3	0.000000	0	0		
		Magnesium (Mg)	7439-95-4	0.000000	0	0		
		Tin (Sn)	7440-31-5	0.000000	0	0		
Lead Frame Total:				0.153600	1000000	306532.1875		
Plating	PMI	Exter. Plating Pb	7439-92-1	0.000000	0	0		
		Exter. Plating Sn	7440-31-5	0.012410	1000000	24766.6230469		
		External Plating Total:				0.012410	1000000	24766.6230469
		Inter. Plating Ni	7440-02-0	0.000000	0	0		
		Inter. Plating Ag	7440-22-4	0.001228	1000000	2450.66088867		
		Internal Plating Total:				0.001228	1000000	2450.66088867
Die Attach	ELECTRICALLY CONDUCTIVE ADHESIVE	Silver (Ag)	7440-22-4	0.001075	750000	2145.32617188		
		Tin (Sn)	7440-31-5	0.000000	0	0		
		Lead (Pb)	7439-92-1	0.000000	0	0		
		Silica (SiO2)	60676-86-0	0.000000	0	0		
		Indium (In)	7440-74-6	0.000000	0	0		
		Metal Oxide		0.000000	0	0		
		Antimony (Sb)	7440-36-0	0.000000	0	0		
		Resin (EP)		0.000358	250000	714.44342041		
Die Attach Total:				0.001433	1000000	2859.76928711		
Encapsulation	FILLED EPOXY RESIN	Resin (EP)		0.078816	240000	157289.3125		
		Bromine (Br)	40039-93-8	0.003284	10000	6553.72167969		
		Silica (SiO2)	60676-86-0	0.236448	720000	471867.96875		
		Antimony Trioxide (Sb2O3)	1309-64-4	0.009852	30000	19661.1640625		
		Metal Hydroxide		0.000000	0	0		
		Carbon Black (C)	1333-86-4	0.000000	0	0		
		Encapsulation Total:				0.328400	1000000	655372.125
Bond Wire Estimated	AFW/TANAKA/ Kn	Gold (Au)	7440-57-5	0.000169	1000000	337.265228271		
					TOTAL MASS (g) :	0.501089		